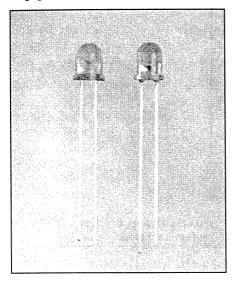
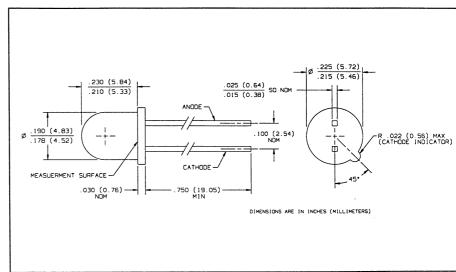


GaAlAs Plastic Infrared Emitting Diodes Types OP293 and OP298 Series





Features

- Wide irradiance pattern (OP293
- Narrow irradiance pattern (OP298
- Mechanically and spectrally matched to the OP593 and OP598 series phototransistors
- Variety of power ranges
- Significantly higher power output than GaAs at equivalent drive currents
- Wavelength matched to silicon's peak response
- Low cost replacement for TO-46 hermetic package

Description

The OP293 and OP298 series devices are 890nm high intensity gallium aluminum arsenide infrared emitting diodes molded in IR transmissive packages. The broad irradiance pattern of the OP293 series provides relatively even illumination over a large area. The OP298 series is focused with an emission angle of 25°.

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Reverse Voltage 2.0 V
Continuous Forward Current, Free Air
Continuous Forward Current, Board Mounted
Continuous Forward Current, Full Heat Sink
Peak Forward Current (25 μs pulse width) 2.0 A
Maximum Duty Cycle (250 μs pulse width, @ 2 A) 5.0%
Storage and Operating Temperature Range40° C to +100° C
Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 sec with soldering
iron]
Power Dissipation, Free Air
Power Dissipation, Board Mounted
Power Dissipation, Full Heat Sink
Notes:
(1) RMA flux is recommended. Duration can be extended to 10 sec max. when flow soldering.

- Max. 20 grams force may be applied to the leads when soldering.
- Measured in Free-Air. Derate power dissipation linearly 1.43 mW/° C above 25° C.
- Mounted on 1/16" (1.6 mm) thick PC board with each lead soldered through 80 mil square lands 0.250° (6.35 mm) below flange of device. Derate power dissipation linearly $2.00~\text{mW/}^\circ$ C above 25° C. (Normal Use)
- Immersed in silicone fluid to simulate infinite heat sink. Derate power dissipation linearly (4) 2.50 mW/° C above 25° C.
- Measurement is taken at the end of a single 100 µs pulse. Heating due to increased pulse rate or pulse width will cause a decrease in reading.
- E_{e(APT)} is a measurement of the average apertured radiant energy incident upon a sensing area 0.250" (6.35 mm) in diameter perpendicular to and centered on the mechanical axis of the lens and 0.420" (10.7 mm) from the measurement surface. $\mathsf{E}_{\mathsf{e}(\mathsf{APT})}$ is not necessarily uniform within the measured area
- Typical Total Power Out (Po) @ IF = 100 mA pulsed on OP293C = 13 mW; (7) OP293B = 18 mW; OP293A = 22 mW.
- E_{e(APT)} is a measurement of the average apertured radiant energy incident upon a sensing area 0.250" (6.5 mm) in diameter perpendicular to and centered on the mechanical axis of the lens and 1.429" (36.30 mm) from the measurement surface. E_{e(APT)} is not necessarily uniform within the measured area.
- For press fit, drill 0.184 ± 0.001 " diameter hole.
- (10) This dimension is held to within \pm 0.005" on the flange edge and may vary \pm 0.020" in the area of the leads.
- Cathode lead is 0.070" nom shorter than anode lead.

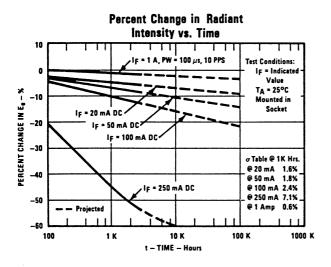
Fax (972) 323-2396 (972) 323-2200

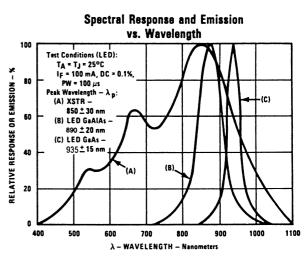
Types OP293 and OP298 Series

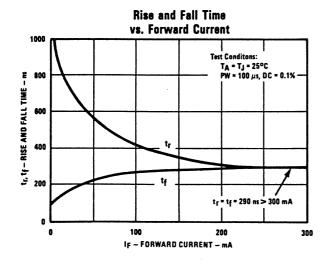
Electrical Characteristics (T_A = 25° C unless otherwise noted)

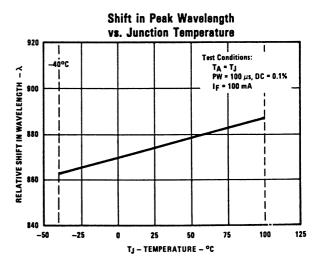
SYMBOL	PARAMETER			TYP	MAX	UNITS	TEST CONDITIONS	
E _{e(APT)}	Apertured Radiant Incidence *OP293 is measured with a 30° cone angle at 0.420" (10.67 mm)	OP293C OP293B OP293A	10 13 16		26	mW/cm ²	I _F = 100 mA ⁽⁵⁾⁽⁶⁾⁽⁷⁾ I _F = 100 mA ⁽⁵⁾⁽⁶⁾⁽⁷⁾ I _F = 100 mA ⁽⁵⁾⁽⁶⁾⁽⁷⁾	
	*OP298 is measured with a 10 ⁰ cone angle at 1.429" (36.30 mm)	OP298C OP298B OP298A	1.8 2.4 3.0		4.8	mW/cm ²	IF = 100 mA ⁽⁵⁾⁽⁶⁾⁽⁷⁾ IF = 100 mA ⁽⁵⁾⁽⁶⁾⁽⁷⁾ IF = 100 mA ⁽⁵⁾⁽⁶⁾⁽⁷⁾	
VF	Forward Voltage				2.0	V	I _F = 1.50 A ⁽⁵⁾	
IR	Reverse Current				100	μА	V _R = 2 V	
λр	Wavelength at Peak Emission			890		nm	I _F = 10 mA	
В	Spectral Bandwidth Between Half Power Points			80		nm	I _F = 10 mA	
Δλρ/ΔΤ	Spectral Shift with Temperature			+0.18		nm/° C	I _F = Constant	
θнР	Emission Angle at Half Power Points	OP293 OP298		60 25		Deg. Deg.	I _F = 20 mA I _F = 20 mA	
t _r	Output Rise Time			500		ns	I _{F(PK)} = 100 mA,	
tf	Output Fall Time			250		ns	PW = 10 μs, D.C. = 10%	

Typical Performance Curves







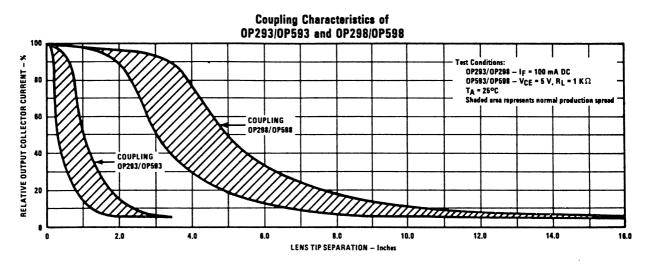


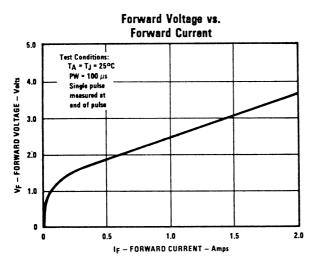
Optek reserves the right to make changes at any time in order to improve design and to supply the best product possible.

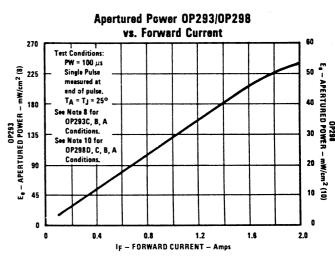
Types OP293 and OP298 Series

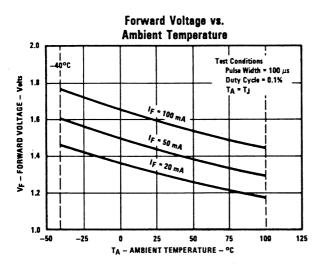


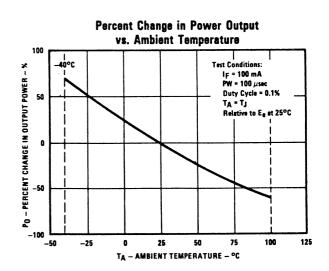
Typical Performance Curves







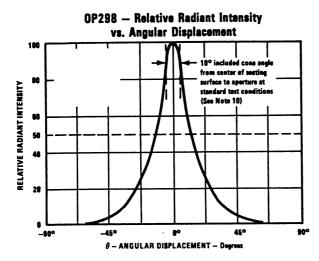


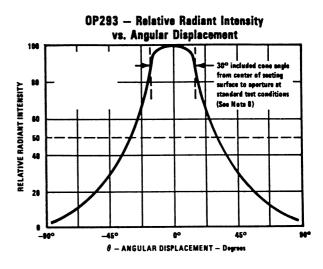


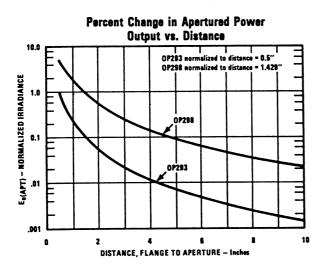
Carrollton, Texas 75006

Types OP293 and OP298 Series

Typical Performance Curves







Thermai Parameters

Туре	R _{THJA} (°C/W)			CTH	$ au_{TH}$	K
Units	Free Air(1)	Normal ⁽²⁾	Infinite Heat Sink ⁽³⁾	(10 ^{.5} Ws/°C)	(10 ⁻² s)	.,
AN	700	500	250	4.0	1.5	800.0

Notes:

- Heat transfer minimized by holding unit in still air with minimum heat transferred through leads by conduction.
 Unit mounted in double sided printed circuit board 0.250 inches
- (2) Unit mounted in double sided printed circuit board 0.250 inches (6.35 mm) below plastic. The land areas are 0.080 inches square. This simulates normal use.
- 3) Unit immersed in circulating silicone fluid holding TCASE @ 25°C. This simulates an infinite heat sink.

Refer to Application Bulletin 200 for use of these constants.